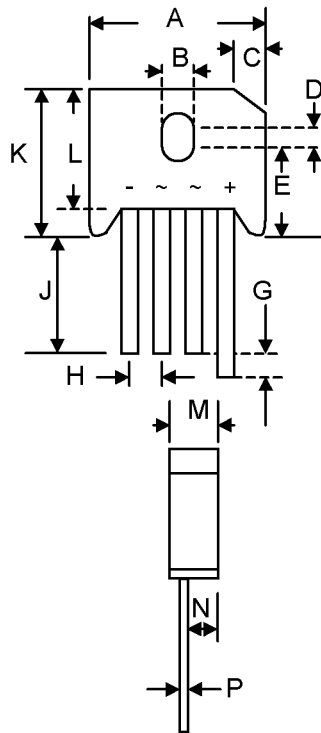


Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards
- UL Recognized File # E157705

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 8.0 grams (approx.)
- Mounting Position: Any
- Marking: Type Number



KBU		
Dim	Min	Max
A	22.70	23.70
B	3.80	4.10
C	4.20	4.70
D	1.70	2.20
E	10.30	11.30
G	4.50	6.80
H	4.60	5.60
J	25.40	—
K	—	19.30
L	16.80	17.80
M	6.60	7.10
N	4.70	5.20
P	1.20	1.30
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	KBU 800	KBU 801	KBU 802	KBU 804	KBU 806	KBU 808	KBU 810	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_c = 100^\circ\text{C}$	I_o	8.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	300							A
Forward Voltage (per element) @ $I_f = 4.0\text{A}$	V_{FM}	1.0							V
Peak Reverse Current @ $T_c = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_c = 100^\circ\text{C}$	I_R	10 1.0							μA mA
Rating for Fusing ($t < 8.3\text{ms}$) (Note 1)	I^2t	373							A^2s
Typical Thermal Resistance (Note 2)	$R_{\theta JC}$	7.5							K/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +150							$^\circ\text{C}$

Note: 1. Non-repetitive for $t > 1\text{ms}$ and $< 8.3\text{ms}$.
2. Thermal resistance junction to case per element mounted on PC board with 13.0x13.0x0.03mm thick land areas.

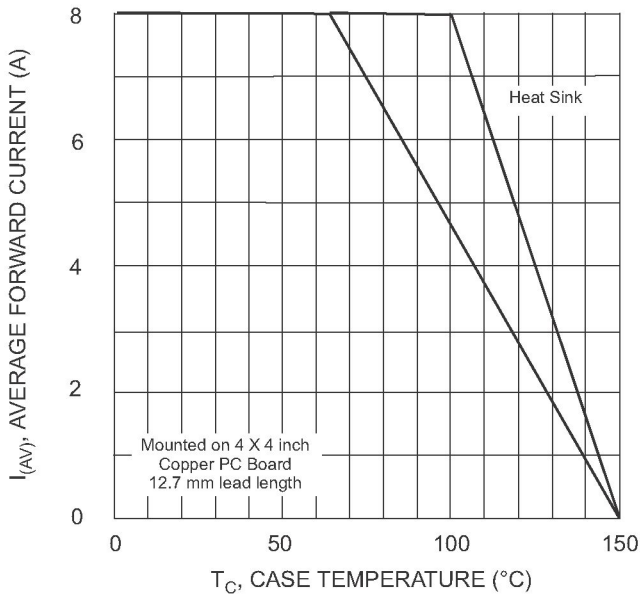


Fig. 1 Forward Current Derating Curve

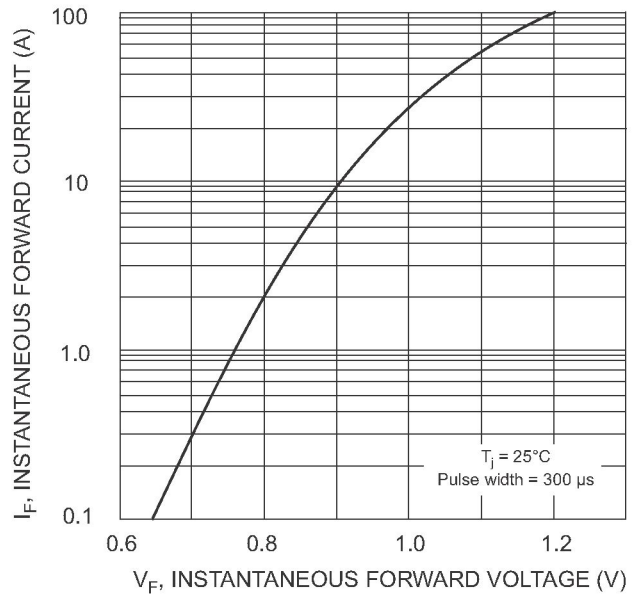


Fig. 2 Typical Forward Characteristics, per element

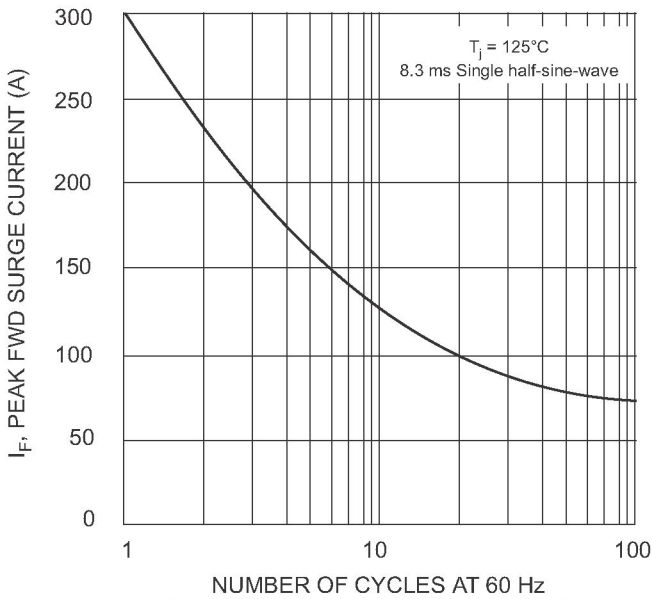


Fig. 3 Max Non-Repetitive Forward Surge Current

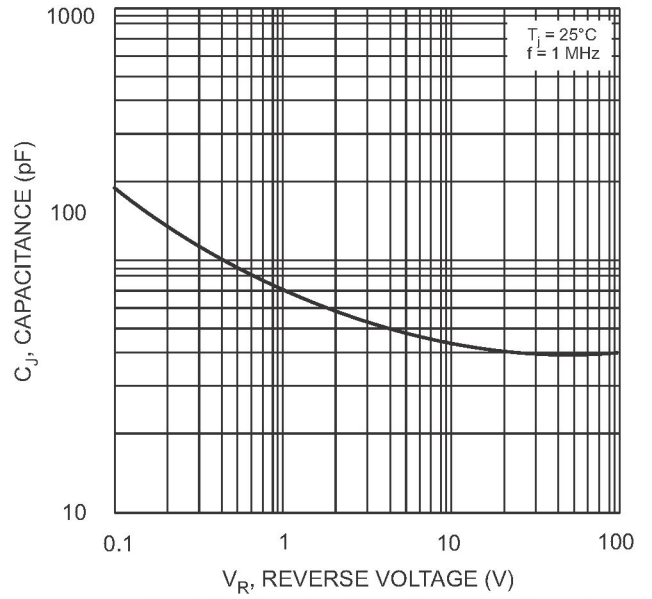


Fig. 4 Typ Junction Capacitance per element

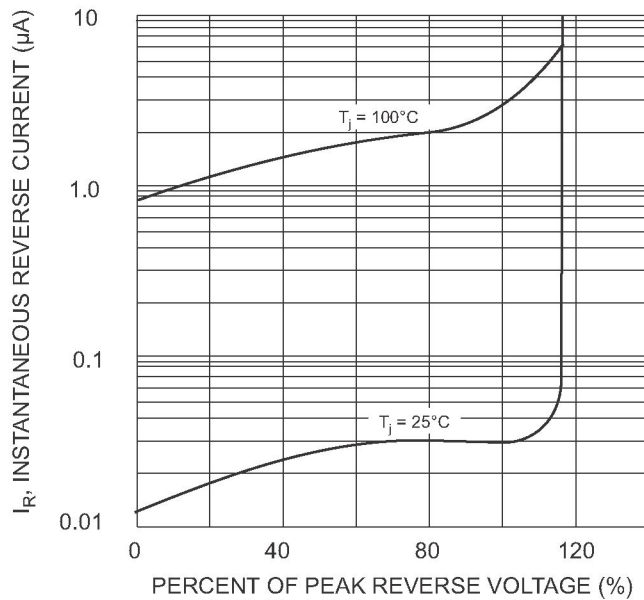


Fig. 5 Typical Reverse Characteristics

ORDERING INFORMATION

Product No.	Package Type	Shipping Quantity
KBU800	SIL Bridge	400 Units/Box
KBU801	SIL Bridge	400 Units/Box
KBU802	SIL Bridge	400 Units/Box
KBU804	SIL Bridge	400 Units/Box
KBU806	SIL Bridge	400 Units/Box
KBU808	SIL Bridge	400 Units/Box
KBU810	SIL Bridge	400 Units/Box

Shipping quantity given is for minimum packing quantity only. For minimum order quantity, please consult the Sales Department.

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